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UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: Group: Attorney Docket # 1980

Applicant(s) : KNOLL, P., ET AL

Serial No. :

Filed :

For : A LAYER THAT CONTAINS ELECTRICALLY, CONDUCTIVE, TRANSPARENT MATERIAL, A METHOD FOR PRODUCING SUCH A LAYER, AND THE USE OF SAID LAYER

INFORMATION DISCLOSURE STATEMENT

January 14, 2002

Honorable Commissioner of Patents
and Trademarks
Washington, D.C. 20231

SIRS:

In accordance with the Duty of Disclosure, Applicant(s) submit(s) herewith a copy of a Foreign Search Report in a counterpart application and copies of the reference(s) indicated therein.

In the event that the Foreign Search Report is in a foreign language, a translation thereof is herewith submitted.

Attached hereto is a FORM PTO 1449 listing the references.

Attached hereto is a copy of a reference cited in the specification of the application as filed. The specification itself recites the relevance of these documents.

Applicant petitions for consideration of this Information Disclosure Statement since it is being submitted after receipt of an office action and submits herewith the required fee. If this fee is missing or insufficient, then authorization is given to debit the account of the undersigned: 19-4675.

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- Attached hereto are copies of references cited which may be pertinent to this application. Since the references are in the English language, no statement of relevance is submitted.
- Attached hereto is a copy of the Office Action issued in the corresponding German application, together with a translation thereof and copies of the references cited therein. A list of the cited references is also attached.
- Attached hereto copies of references cited which may be pertinent to this application. An English translation of the references is also attached.
- Attached hereto is a Statement of Relevancy and copies of references cited therein.
- These references were sent to the USPTO by WIPO and are in the file of this application.

Respectfully submitted,



Michael J. Striker
Attorney for Applicant(s)
Reg. No. 27233